Novel Thin Film Sensor Technology for Turbine Engine Hot Section Components

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**Abstract**

Degradation and damage that develops over time in hot section components can lead to catastrophic failure of the turbine section of aircraft engines. A range of thin film sensor technology has been demonstrated enabling on-component measurement of multiple parameters either individually or in sensor arrays including temperature, strain, heat flux, and flow. Conductive ceramics are beginning to be investigated as new materials for use as thin film sensors in the hot section, leveraging expertise in thin films and high temperature materials. The current challenges are to develop new sensor and insulation materials capable of withstanding the extreme hot section environment, and to develop techniques for applying sensors onto complex high temperature structures for aging studies of hot propulsion materials. The technology research and development ongoing at NASA Glenn Research Center for applications to future aircraft, launch vehicles, space vehicles, and ground systems is outlined.
Novel Thin Film Sensor Technology for Turbine Engine Hot Section Components

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The Researchers

John Wrbanek & Gus Fralick

- Research Engineers / Physicists at NASA Glenn Research Center
- Sensors & Electronics Branch (GRC/RIS)

- Primarily Physical Sensors Instrumentation Research:
  - Thin Film Sensors
  - Temperature
  - Strain
  - Flow

- Also dabble in Radiation Detectors, and Research in Sonoluminescence & Other Revolutionary Concepts
Outline

- Introduction
- Thin Film Physical Sensors at GRC
- Ceramics as Thermocouples
  - CrSi\textsubscript{2}/TaC test
- Ceramics as Static Strain Gauges
  - AFRL/NASA Space Act Agreement (SAA)
- Aircraft Aging & Durability Project
  - Novel Thin Film Sensor Technology for Aging Component NDE
NASA’s Mission: To pioneer the future in space exploration, scientific discovery, and aeronautics research

“Advance knowledge in the fundamental disciplines of aeronautics, and develop technologies for safer aircraft and higher capacity airspace systems.”
– NASA 2006 Strategic Plan

“Develop the innovative technologies, knowledge, and infrastructures both to explore and support decisions about the destinations for human exploration”
– Vision for Space Exploration
Instrumentation Challenges for Propulsion System Environments

- High gas temperatures
- High material temperatures (>1000°C)
- Rapid thermal transients
- High gas flows
- High combustion chamber pressures

Wire-based sensors are bulky and disruptive to the true operating environment
Physical Issues for Life Prediction of Engine Hot Section

- Centrifugal Stress
- Thermal Stress
- Vibrational Stress from gas flow
- Contact Stresses from different materials (Thermal Expansions, Deformations)
- Blade Clearance (Creep)
Thin Film Physical Sensors for High Temperature Applications

Advantages for temperature, strain, heat flux, flow & pressure measurements:
- Negligible mass & minimally intrusive (microns thick)
- Applicable to a variety of materials including ceramics
- Minimal structural disturbance (minimal machining)
- Intimate sensor to substrate contact & accurate placement
- High durability compared to exposed wire sensors
- Capable for operation to very high temperatures (>1000°C)

Multifunctional smart sensors being developed

PdCr strain sensor to T=1000°C
Pt- Pt/Rh temperature sensor to T=1200°C
Heat Flux Sensor Array to T=1000°C
Multifunctional Sensor Array

Flow sensor made of high temperature materials
Physical Sensors Facilities

Sensing Film layers are fabricated with physical vapor deposition methods (sputter deposition, e-beam vapor deposition)

Sensors are patterned by photolithography methods and/or stenciled masks

Evaluation of thin films with in-house Materials Characterization Facilities

Testing of films with in-house high-temperature furnaces & burn rigs

SEM/EDAX

IRL Thin Film Lab

ERB Burn Rig
Multi-Functional Sensor System

• Multifunctional thin film sensor designed and built in-house (US Patent 5,979,243)
• Temperature, strain, and heat flux with flow all one the same microsensor
• Enables measurements on component surfaces, and reduces boundary layer trip on metals compared to wires or foils
• Weldable shim designed to simplify sensor mounting
• Dynamic measurements demonstrated in lab
Application of Ceramics as Thin Film Sensors

- The limits of noble metal thin film sensors of 1100°C (2000°F) may not be adequate for the increasingly harsh conditions of advanced aircraft and launch technology (>1650°C/3000°F)
- NASA GRC investigating ceramics as thin film sensors for extremely high temperature applications
- Advantages of the stability and robustness of ceramics and the non-intrusiveness of thin films
- Advances have been made in ceramic thin film sensors through collaborations with Case Western Reserve University (CWRU) and University of Rhode Island (URI)
Considerations for Ceramic Thermocouples

- Silicides and Carbides have highest thermoelectric output of non-metallic thermocouple (TC) elements as bulk materials
- Carbides have a very high use temperature in inert and reducing atmospheres (>>3000°C)
- Most Robust Carbides: TaC, HfC, and ZrC
- Silicides form a natural passivation layer in oxygen
- High Performance Silicides: CrSi₂ and TaSi₂

- Ceramic TC Sample fabricated on-site in Microsystems Fabrication Clean Room Facility using magnetron sputtering and shadow-masks

CrSi$_2$/TaC vs. Pt Test Run

- Initial Testing in air to assess the high temperature response and capabilities
CrSi$_2$ & TaC vs. Pt Thermoelectric Voltage

![Graphs showing CrSi$_2$ vs. Pt and TaC vs. Pt thermoelectric voltage vs. temperature](image)

**Linear Fit**
- CrSi$_2$ vs. Pt
  \[ V(T^\circ C)_{T_1=0} = 0.1022075 \times T \ [\text{mVolts}] \]
- TaC vs. Pt
  \[ V(T^\circ C)_{T_1=0} = -0.004296 \times T \ [\text{mVolts}] \]

- Oxidation will cause a shift in carrier concentration, which is suspected to be causing the cubic response.
- Linear fit may be more indicative of response in inert environments.
Considerations for Static Strain Gauges

- Required accuracy: ±200 με (±10% full scale)
  - Currently accomplished with a temperature compensating bridge circuit with PdCr
- Multifunctional Sensor design does not lend itself to compensating bridges
  - Multiple strain gauges in a rosette pattern does not allow compensation to be included in design
  - Design eliminates temperature effects if apparent strain is low enough
- High Temperature Static Strain measurements with Multifunctional Sensor requires a more passive method of reducing or eliminating apparent strain
- Temperature Sensitivity Goal for Multifunctional Sensor algorithm: <±20 με/°C
**Apparent Strain**

- **Gauge factor** ($\gamma$) of the strain gauge relates the sensitivity of the gauge to **Strain** ($\varepsilon$):
  \[
  \frac{\delta R}{R} = \gamma \frac{\delta l}{l} = \gamma \varepsilon
  \]

- **Apparent Strain** ($\varepsilon_a$) can be falsely interpreted as actual strain due to the gauge’s **Temperature Coefficient of Resistance (TCR)** and **Coefficient of Thermal Expansion (CTE)**:
  \[
  \frac{\varepsilon_a}{\Delta T} = \frac{TCR}{\gamma} + \Delta CTE
  \]

- **Goal**: To minimize apparent strain by minimizing TCR and maximizing gauge factor
Tantalum Nitride Sensor Fabrication

TaN Test Films (2004)
- Reactively-sputtered
- Patterned using shadow masks

TaN Multifunctional Rosette (2005)
- Patterned using lift-off
- Gauge Factor: 3.9
- Resistivity: 259 µΩ-cm @20°C
- TCR: -93 ppm/°C
- $\varepsilon_a/\Delta T$: -24 µε/°C (>20µε/°C)
Multilayered Multifunctional Sensor

- TaN layered to PdCr strain gauge for the passive elimination of apparent strain sensitivity
- Initial test to 150°C (2006)
  - Gauge Factor: 1.2
  - Resistivity: 146 µΩ-cm
  - TCR: +15 ppm/°C
  - ε_α/ΔT: +12 με/°C (<20με/°C)
- Follow-up test to 600°C (2007)
  - Output unstable: ε_α/ΔT: +71 με/°C (>20με/°C)
- Potential Issues
  - Multilayer Delamination / Diffusion
  - Compatible with sacrificial lift-off patterning process (Reactivity)
  - High Temperature Expansion Issues (CTE)
- Other Materials? (AFRL NDE)

• Reactivity restrictions allow:
  – Ta, Cr, Al, Au
  – TiO, ITO, CrSiO, TiB$_2$
  – TaN, TiN, ZrN
• CTE Issues?
  – TiO, ITO, CrSiO, TiB$_2$, TiN, ZrN
• Procurements (2006)
  – Targets & Substrates
  – Equipment & Clean Room Support
• Test to Increasing Temperatures
  – 200°C, 700°C, 1300°C +
• TCR, $\varepsilon_a/\Delta T$, Drift Rate
• Other Formulations?

Low Temperature Testing

<table>
<thead>
<tr>
<th>Film</th>
<th>Ar/N/O flow mix</th>
<th>Deposition Time</th>
<th>Thickness</th>
<th>Resistivity</th>
<th>TCR</th>
<th>ΔRₒ for 200°C Cycle</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ti</td>
<td>40/0/0</td>
<td>369 min.</td>
<td>2.0 μm</td>
<td>133 μΩ-cm</td>
<td>1360 ppm/°C</td>
<td>4.45%</td>
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<tr>
<td>TiN</td>
<td>38/2/0</td>
<td>1200 min.</td>
<td>2.8 μm</td>
<td>1490 μΩ-cm</td>
<td>624 ppm/°C</td>
<td>114%</td>
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<tr>
<td>TiON</td>
<td>18/1/0.5</td>
<td>360 min.</td>
<td>0.6 μm</td>
<td>62 μΩ-cm</td>
<td>1400 ppm/°C</td>
<td>0.83%</td>
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<tr>
<td>Zr</td>
<td>40/0/0</td>
<td>198 min.</td>
<td>2.0 μm</td>
<td>140 μΩ-cm</td>
<td>1090 ppm/°C</td>
<td>2.73%</td>
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<td>ZrN</td>
<td>38/2/0</td>
<td>750 min.</td>
<td>2.4 μm</td>
<td>1090 μΩ-cm</td>
<td>146 ppm/°C</td>
<td>4.26%</td>
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<tr>
<td>ZrON</td>
<td>18/1/0.5</td>
<td>360 min.</td>
<td>1.7 μm</td>
<td>82 μΩ-cm</td>
<td>695 ppm/°C</td>
<td>-1.3%</td>
</tr>
</tbody>
</table>

- All films fabricated using a 3” unbalanced magnetron source at 125W RF
- All films patterned & vacuum annealed at 600°C
- TCR tested using a 4-wire method to 200°C
- N-doping lowered TCR (not enough)
- ON films more stable in air
- Examining Al incorporation, multilayered films
Problem:
- Degradation and damage that develops over time in hot section components can lead to catastrophic failure.
- Poor characterization of degradation processes in harsh environment conditions hinders development of durable hot section components

Demonstrated Need:
- Very difficult to model turbine blade temperatures, strains, heat fluxes; measurements are needed
- The turbine section has been consistently responsible for >$40M/yr in losses to the Air Force

Project Content:
- Develop new sensor and insulation materials capable of withstanding the hot section environment
- Develop techniques for applying sensors onto complex high temperature structures
- Develop thin film sensors to measure temperature, strain, and heat flux during aging studies for hot propulsion materials.

Current SOA:
- Wire thermocouples, strain gauges-disrupt flow, change thermal & mechanical behavior of substrate
- Metal thin films, NiCoCrALY insulation

Value Added, Contribution of Research:
- New bulk and nano-structured sensor materials with tailored properties
- Novel thin film harsh environment sensors for high temperature characterizations

Glenn Research Center - Sensors and Electronics Branch
## Summary of Ceramics of Interest and Application

<table>
<thead>
<tr>
<th>Ceramic</th>
<th>Thermocouple</th>
<th>RTD</th>
<th>Strain Gauge</th>
<th>Flow Sensor</th>
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<tr>
<td>TiC</td>
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<td>CrSi₂</td>
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</tr>
<tr>
<td>TiB₂</td>
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</tbody>
</table>

- Film Fabrication and Testing a challenge; Purity large concern
Summary

• For the advanced engines in the future, knowledge of the physical parameters of the engine and components is necessary on the test stand and in flight
• NASA GRC is leveraging expertise in thin films and high temperature materials, investigations for the applications of thin film ceramic sensors
• High output ceramic thermocouples have been demonstrated
• Attempts to improve thermal stability with Tantalum Nitride with an interlayered Palladium-Chromium strain gauge was met with positive results initially, but proved unstable
• Under AFRL/NASA SSA, began examination of other nitrides as possible candidates for ultra-high temperature strain gauges
• Currently examining sputtered films of candidate materials as sensors through NASA’s Aircraft Aging & Durability Project
Acknowledgements

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- NASA GRC Ceramics Branch, CWRU & URI for collaborative support.
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